

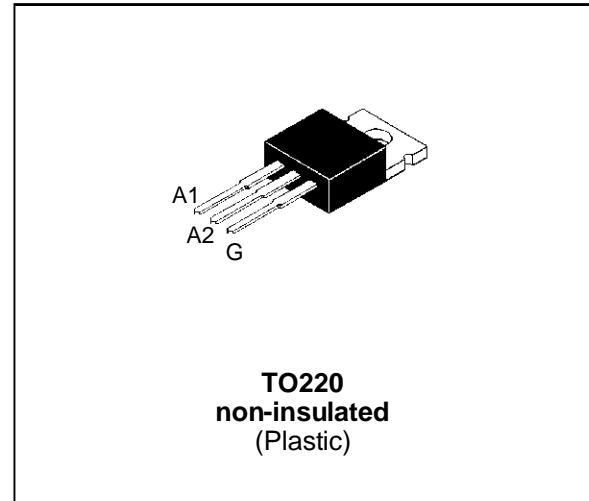
SENSITIVE GATE TRIACS

FEATURES

- $I_{T(RMS)} = 6A$
- $V_{DRM} = 400V$ to $800V$
- $I_{GT} \leq 5mA$ to $\leq 10mA$

DESCRIPTION

The T06xxxH series of triacs uses a high performance MESA GLASS technology. These parts are intended for general purpose applications where gate high sensitivity is required.



ABSOLUTE RATINGS (limiting values)

Symbol	Parameter		Value	Unit
$I_{T(RMS)}$	RMS on-state current (360° conduction angle)	$T_c = 100\text{ }^\circ\text{C}$	6	A
I_{TSM}	Non repetitive surge peak on-state current (T_j initial = 25°C)	$t_p = 8.3\text{ ms}$	63	A
		$t_p = 10\text{ ms}$	60	
I^2t	I^2t Value for fusing	$t_p = 10\text{ ms}$	18	A^2s
di/dt	Critical rate of rise of on-state current $I_G = 50\text{ mA}$ $di_G/dt = 0.1\text{ A}/\mu\text{s}$.	Repetitive $F = 50\text{ Hz}$	10	$A/\mu\text{s}$
		Non Repetitive	50	
T_{stg} T_j	Storage and operating junction temperature range		- 40, + 150 - 40, + 125	$^\circ\text{C}$
T_l	Maximum lead temperature for soldering during 10s at 4.5mm from case		260	$^\circ\text{C}$

Symbol	Parameter	Voltage				Unit
		D	M	S	N	
V_{DRM} V_{RRM}	Repetitive peak off-state voltage $T_j = 125^\circ\text{C}$	400	600	700	800	V

T0605xH / T0609xH**THERMAL RESISTANCES**

Symbol	Parameter	Value	Unit
Rth(j-a)	Junction to ambient	60	°C/W
Rth(j-c)	Junction to case for D.C	4	°C/W
Rth(j-c)	Junction to case for A.C 360° conduction angle (F=50Hz)	3	°C/W

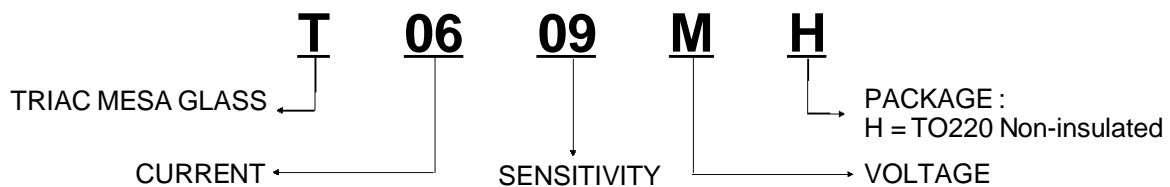
GATE CHARACTERISTICS (maximum values)

$P_G (AV) = 1 W$ $P_{GM} = 10 W$ ($t_p = 20 \mu s$) $I_{GM} = 4 A$ ($t_p = 20 \mu s$)

ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions	Quadrant		Sensitivity		Unit
				05	09	
I_{GT}	$V_D = 12V$ (DC) $R_L = 33\Omega$ $T_j = 25^\circ C$	I-II-III-IV	MAX	5	10	mA
V_{GT}	$V_D = 12V$ (DC) $R_L = 33\Omega$ $T_j = 25^\circ C$	I-II-III-IV	MAX	1.5		V
V_{GD}	$V_D = V_{DRM}$ $R_L = 3.3k\Omega$ $T_j = 125^\circ C$	I-II-III-IV	MIN	0.2		V
tgt	$V_D = V_{DRM}$ $I_G = 40mA$ $I_T = 8.5A$ $di_G/dt = 0.5A/\mu s$ $T_j = 25^\circ C$	I-II-III-IV	TYP	2		μs
I_H^*	$I_T = 50mA$ Gate open $T_j = 25^\circ C$		MAX	5	10	mA
I_L	$I_G = 1.2 I_{GT}$ $T_j = 25^\circ C$	I-III-IV	TYP	5	10	mA
		II	TYP	10	20	
V_{TM}^*	$I_{TM} = 8.5A$ $t_p = 380\mu s$ $T_j = 25^\circ C$		MAX	1.65		V
I_{DRM} I_{RRM}	$V_D = V_{DRM}$ $V_R = V_{RRM}$ $T_j = 25^\circ C$		MAX	5		μA
			MAX	2		mA
dV/dt *	$V_D = 67\% V_{DRM}$ Gate open $T_j = 110^\circ C$		MIN		20	V/ μs
			TYP	10		
(dV/dt)c *	(di/dt)c = 2.7 A/ms $T_j = 110^\circ C$		TYP	1	2	V/ μs

* For either polarity of electrode A_2 voltage with reference to electrode A_1

ORDERING INFORMATION

T0605xH / T0609xH

Fig.1 : Maximum RMS power dissipation versus RMS on-state current.

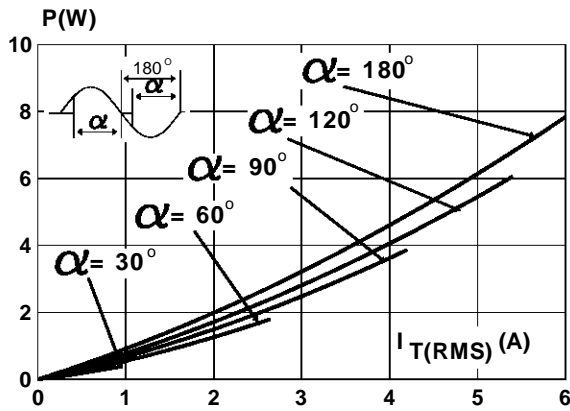


Fig.2 : Correlation between maximum RMS power dissipation and maximum allowable temperature (Tamb and Tcase) for different thermal resistances heatsink + contact.

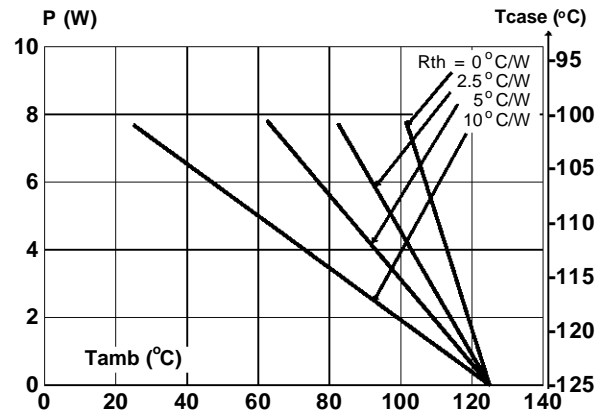


Fig.3 : RMS on-state current versus case temperature.

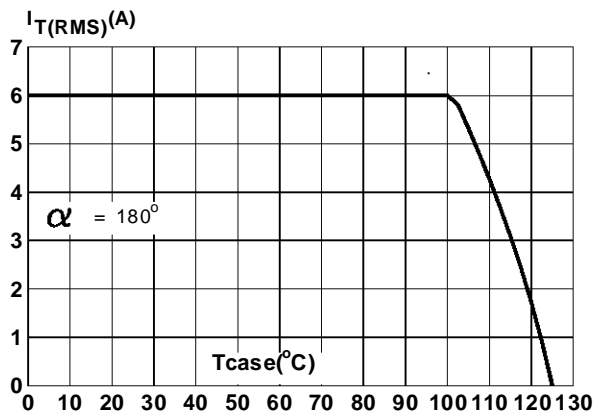


Fig.4 : Relative variation of thermal impedance versus pulse duration.

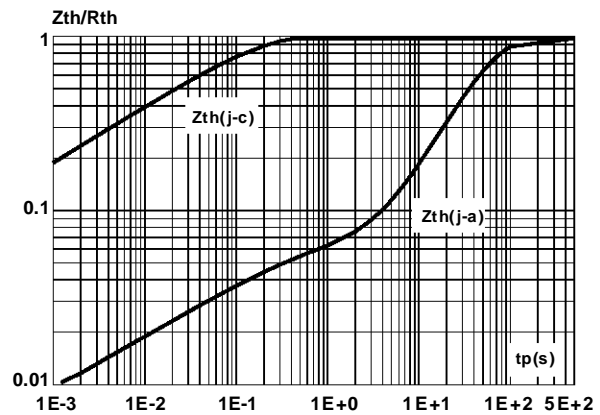


Fig.5 : Relative variation of gate trigger current and holding current versus junction temperature.

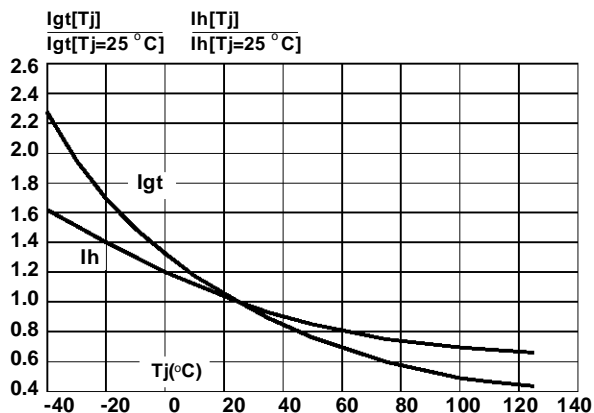
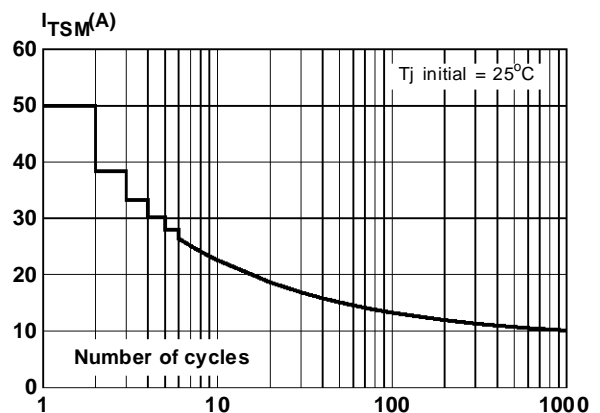


Fig.6 : Non repetitive surge peak on-state current versus number of cycles.



T0605xH / T0609xH

Fig.7 : Non repetitive surge peak on-state current for a sinusoidal pulse with width : $t \leq 10\text{ms}$, and corresponding value of I^2t .

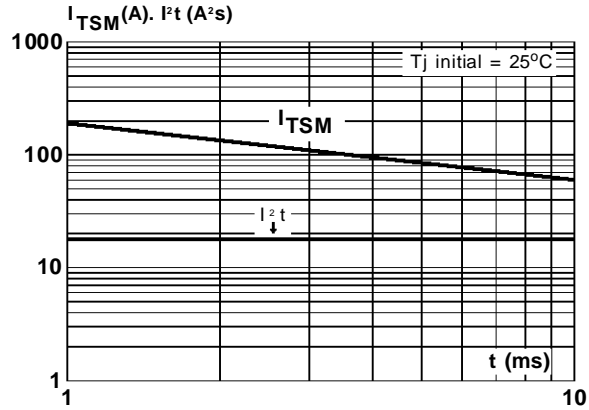
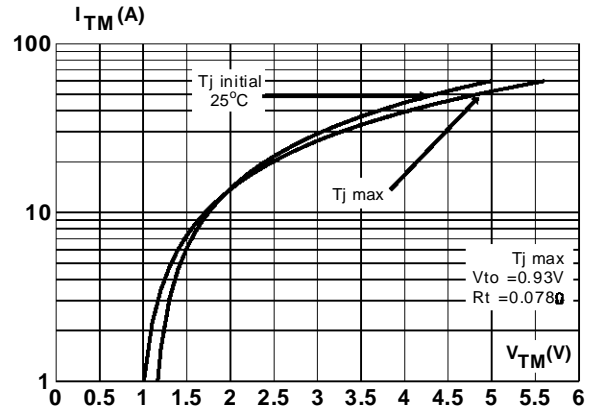


Fig.8 : On-state characteristics (maximum values).



T0605xH / T0609xH**PACKAGE MECHANICAL DATA**
TO220 Non-insulated (Plastic)

REF.	DIMENSIONS					
	Millimeters			Inches		
	Typ.	Min.	Max.	Typ.	Min.	Max.
A			10.3			0.406
B		6.3	6.5	0.248	0.256	
C			9.1			0.358
D		12.7			0.500	
F			4.2			0.165
G			3.0			0.118
H		4.5	4.7		0.177	0.185
I		3.53	3.66		0.139	0.144
J		1.2	1.3		0.047	0.051
L			0.9			0.035
M	2.7			0.106		
N			5.3			0.209
N1	2.54			0.100		
O		1.2	1.4		0.047	0.055
P			1.15			0.045

Marking : type number
Weight : 1.8 g

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